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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Discontinued at Digi-Key
Core Processor	C166SV2
Core Size	16-Bit
Speed	40MHz
Connectivity	EBI/EMI, SPI, UART/USART
Peripherals	PWM, WDT
Number of I/O	79
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	12K x 8
Voltage - Supply (Vcc/Vdd)	2.35V ~ 2.7V
Data Converters	A/D 14x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	PG-TQFP-100-5
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/saf-xc164s-32f40f-bb

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Data Sheet, V1.0, Aug. 2006

XC164S-32F/32R

16-Bit Single-Chip Microcontroller with C166SV2 Core

Microcontrollers

Never stop thinking

Table 2 Pin Definitions and Functions

Symbol	Pin Num.	Input Outp.	Function
$\overline{\text{RSTIN}}$	1	I	Reset Input with Schmitt-Trigger characteristics. A low level at this pin while the oscillator is running resets the XC164S. A spike filter suppresses input pulses < 10 ns. Input pulses > 100 ns safely pass the filter. The minimum duration for a safe recognition should be 100 ns + 2 CPU clock cycles. *Note: The reset duration must be sufficient to let the hardware configuration signals settle. External circuitry must guarantee low level at the $\overline{\text{RSTIN}}$ pin at least until both power supply voltages have reached the operating range.*
P20.12	2	IO	For details, please refer to the description of **P20**.
$\overline{\text{NMI}}$	3	I	Non-Maskable Interrupt Input. A high to low transition at this pin causes the CPU to vector to the NMI trap routine. When the PWRDN (power down) instruction is executed, the $\overline{\text{NMI}}$ pin must be low in order to force the XC164S into power down mode. If $\overline{\text{NMI}}$ is high, when PWRDN is executed, the part will continue to run in normal mode. If not used, pin $\overline{\text{NMI}}$ should be pulled high externally.
P0H.0- P0H.3	4…7	IO	For details, please refer to the description of **PORT0**.
P9		IO	Port 9 is a 6-bit bidirectional I/O port. Each pin can be programmed for input (output driver in high-impedance state) or output (configurable as push/pull or open drain driver). The input threshold of Port 9 is selectable (standard or special). The following Port 9 pins also serve for alternate functions:
P9.0	10	I/O	CC16IO CAPCOM2: CC16 Capture Inp./Compare Outp.,
		I	EX7IN Fast External Interrupt 7 Input (alternate pin B)
P9.1	11	I/O	CC17IO CAPCOM2: CC17 Capture Inp./Compare Outp.,
		I	EX6IN Fast External Interrupt 6 Input (alternate pin B)
P9.2	12	I/O	CC18IO CAPCOM2: CC18 Capture Inp./Compare Outp.,
		I	EX7IN Fast External Interrupt 7 Input (alternate pin A)
P9.3	13	I/O	CC19IO CAPCOM2: CC19 Capture Inp./Compare Outp.,
		I	EX6IN Fast External Interrupt 6 Input (alternate pin A)
P9.4	14	I/O	CC20IO CAPCOM2: CC20 Capture Inp./Compare Outp.
P9.5	15	I/O	CC21IO CAPCOM2: CC21 Capture Inp./Compare Outp.

Table 2 Pin Definitions and Functions (cont'd)

Symbol	Pin Num.	Input Outp.	Function
P20		IO	Port 20 is a 5-bit bidirectional I/O port. Each pin can be programmed for input (output driver in high-impedance state) or output. The input threshold of Port 20 is selectable (standard or special). The following Port 20 pins also serve for alternate functions:
P20.0	63	O	$\overline{\text{RD}}$ External Memory Read Strobe, activated for every external instruction or data read access.
P20.1	64	O	$\overline{\text{WR}}$/$\overline{\text{WRL}}$ External Memory Write Strobe. In $\overline{\text{WR}}$-mode this pin is activated for every external data write access. In $\overline{\text{WRL}}$-mode this pin is activated for low byte data write accesses on a 16-bit bus, and for every data write access on an 8-bit bus.
P20.4	65	O	ALE Address Latch Enable Output. Can be used for latching the address into external memory or an address latch in the multiplexed bus modes.
P20.5	66	I	$\overline{\text{EA}}$ External Access Enable pin. **A low level** at this pin during and after Reset forces the XC164S to latch the configuration from PORT0 and pin $\overline{\text{RD}}$, and to begin instruction execution out of external memory. **A high level** forces the XC164S to latch the configuration from pins $\overline{\text{RD}}$, ALE, and $\overline{\text{WR}}$, and to begin instruction execution out of the internal program memory. "ROMless" versions must have this pin tied to '0'.
P20.12	2	O	$\overline{\text{RSTOUT}}$ Internal Reset Indication Output. **Is activated** asynchronously with an external hardware reset. It may also be activated (selectable) synchronously with an internal software or watchdog reset. **Is deactivated** upon the execution of the EINIT instruction, optionally at the end of reset, or at any time (before EINIT) via user software.
			Note: Port 20 pins may input configuration values (see $\overline{\text{EA}}$).

Table 2 Pin Definitions and Functions (cont'd)

Symbol	Pin Num.	Input Outp.	Function
V_{DDI}	35, 97	–	Digital Core Supply Voltage (On-Chip Modules): +2.5 V during normal operation and idle mode. Please refer to the **Operating Conditions**
V_{DDP}	9, 17, 38, 61, 87	–	Digital Pad Supply Voltage (Pin Output Drivers): +5 V during normal operation and idle mode. Please refer to the **Operating Conditions**
V_{SSI}	34, 98	–	**Digital Ground.** Connect decoupling capacitors to adjacent V_{DD}/V_{SS} pin pairs as close as possible to the pins. All V_{SS} pins must be connected to the ground-line or ground-plane.
V_{SSP}	8, 16, 37, 62, 88	–	

Table 4 XC164S Interrupt Nodes (cont'd)

Source of Interrupt or PEC Service Request	Control Register	Vector Location[1)]	Trap Number
CAPCOM Register 29	CC2_CC29IC	$xx'0110_H$	44_H / 68_D
CAPCOM Register 30	CC2_CC30IC	$xx'0114_H$	45_H / 69_D
CAPCOM Register 31	CC2_CC31IC	$xx'0118_H$	46_H / 70_D
CAPCOM Timer 0	CC1_T0IC	$xx'0080_H$	20_H / 32_D
CAPCOM Timer 1	CC1_T1IC	$xx'0084_H$	21_H / 33_D
CAPCOM Timer 7	CC2_T7IC	$xx'00F4_H$	$3D_H$ / 61_D
CAPCOM Timer 8	CC2_T8IC	$xx'00F8_H$	$3E_H$ / 62_D
GPT1 Timer 2	GPT12E_T2IC	$xx'0088_H$	22_H / 34_D
GPT1 Timer 3	GPT12E_T3IC	$xx'008C_H$	23_H / 35_D
GPT1 Timer 4	GPT12E_T4IC	$xx'0090_H$	24_H / 36_D
GPT2 Timer 5	GPT12E_T5IC	$xx'0094_H$	25_H / 37_D
GPT2 Timer 6	GPT12E_T6IC	$xx'0098_H$	26_H / 38_D
GPT2 CAPREL Register	GPT12E_CRIC	$xx'009C_H$	27_H / 39_D
A/D Conversion Complete	ADC_CIC	$xx'00A0_H$	28_H / 40_D
A/D Overrun Error	ADC_EIC	$xx'00A4_H$	29_H / 41_D
ASC0 Transmit	ASC0_TIC	$xx'00A8_H$	$2A_H$ / 42_D
ASC0 Transmit Buffer	ASC0_TBIC	$xx'011C_H$	47_H / 71_D
ASC0 Receive	ASC0_RIC	$xx'00AC_H$	$2B_H$ / 43_D
ASC0 Error	ASC0_EIC	$xx'00B0_H$	$2C_H$ / 44_D
ASC0 Autobaud	ASC0_ABIC	$xx'017C_H$	$5F_H$ / 95_D
SSC0 Transmit	SSC0_TIC	$xx'00B4_H$	$2D_H$ / 45_D
SSC0 Receive	SSC0_RIC	$xx'00B8_H$	$2E_H$ / 46_D
SSC0 Error	SSC0_EIC	$xx'00BC_H$	$2F_H$ / 47_D
PLL/OWD	PLLIC	$xx'010C_H$	43_H / 67_D
ASC1 Transmit	ASC1_TIC	$xx'0120_H$	48_H / 72_D
ASC1 Transmit Buffer	ASC1_TBIC	$xx'0178_H$	$5E_H$ / 94_D
ASC1 Receive	ASC1_RIC	$xx'0124_H$	49_H / 73_D
ASC1 Error	ASC1_EIC	$xx'0128_H$	$4A_H$ / 74_D
ASC1 Autobaud	ASC1_ABIC	$xx'0108_H$	42_H / 66_D
End of PEC Subchannel	EOPIC	$xx'0130_H$	$4C_H$ / 76_D

The XC164S also provides an excellent mechanism to identify and to process exceptions or error conditions that arise during run-time, so-called 'Hardware Traps'. Hardware traps cause immediate non-maskable system reaction which is similar to a standard interrupt service (branching to a dedicated vector table location). The occurrence of a hardware trap is additionally signified by an individual bit in the trap flag register (TFR). Except when another higher prioritized trap service is in progress, a hardware trap will interrupt any actual program execution. In turn, hardware trap services can normally not be interrupted by standard or PEC interrupts.

Table 5 shows all of the possible exceptions or error conditions that can arise during run-time:

Table 5 Hardware Trap Summary

Exception Condition	Trap Flag	Trap Vector	Vector Location[1]	Trap Number	Trap Priority
Reset Functions:	–				
• Hardware Reset		RESET	xx'0000$_H$	00$_H$	III
• Software Reset		RESET	xx'0000$_H$	00$_H$	III
• Watchdog Timer Overflow		RESET	xx'0000$_H$	00$_H$	III
Class A Hardware Traps:					
• Non-Maskable Interrupt	NMI	NMITRAP	xx'0008$_H$	02$_H$	II
• Stack Overflow	STKOF	STOTRAP	xx'0010$_H$	04$_H$	II
• Stack Underflow	STKUF	STUTRAP	xx'0018$_H$	06$_H$	II
• Software Break	SOFTBRK	SBRKTRAP	xx'0020$_H$	08$_H$	II
Class B Hardware Traps:					
• Undefined Opcode	UNDOPC	BTRAP	xx'0028$_H$	0A$_H$	I
• PMI Access Error	PACER	BTRAP	xx'0028$_H$	0A$_H$	I
• Protected Instruction Fault	PRTFLT	BTRAP	xx'0028$_H$	0A$_H$	I
• Illegal Word Operand Access	ILLOPA	BTRAP	xx'0028$_H$	0A$_H$	I
Reserved	–	–	[2C$_H$ - 3C$_H$]	[0B$_H$ - 0F$_H$]	–
Software Traps • TRAP Instruction	–	–	Any [xx'0000$_H$ - xx'01FC$_H$] in steps of 4$_H$	Any [00$_H$ - 7F$_H$]	Current CPU Priority

1) Register VECSEG defines the segment where the vector table is located to.

compare function.
12 registers of the CAPCOM2 module have each one port pin associated with it which serves as an input pin for triggering the capture function, or as an output pin to indicate the occurrence of a compare event.

Table 6 Compare Modes (CAPCOM1/2)

Compare Modes	Function
Mode 0	Interrupt-only compare mode; several compare interrupts per timer period are possible
Mode 1	Pin toggles on each compare match; several compare events per timer period are possible
Mode 2	Interrupt-only compare mode; only one compare interrupt per timer period is generated
Mode 3	Pin set '1' on match; pin reset '0' on compare timer overflow; only one compare event per timer period is generated
Double Register Mode	Two registers operate on one pin; pin toggles on each compare match; several compare events per timer period are possible
Single Event Mode	Generates single edges or pulses; can be used with any compare mode

When a capture/compare register has been selected for capture mode, the current contents of the allocated timer will be latched ('captured') into the capture/compare register in response to an external event at the port pin which is associated with this register. In addition, a specific interrupt request for this capture/compare register is generated. Either a positive, a negative, or both a positive and a negative external signal transition at the pin can be selected as the triggering event.

The contents of all registers which have been selected for one of the five compare modes are continuously compared with the contents of the allocated timers.

When a match occurs between the timer value and the value in a capture/compare register, specific actions will be taken based on the selected compare mode.

3.8 General Purpose Timer (GPT12E) Unit

The GPT12E unit represents a very flexible multifunctional timer/counter structure which may be used for many different time related tasks such as event timing and counting, pulse width and duty cycle measurements, pulse generation, or pulse multiplication.

The GPT12E unit incorporates five 16-bit timers which are organized in two separate modules, GPT1 and GPT2. Each timer in each module may operate independently in a number of different modes, or may be concatenated with another timer of the same module.

Each of the three timers T2, T3, T4 of **module GPT1** can be configured individually for one of four basic modes of operation, which are Timer, Gated Timer, Counter, and Incremental Interface Mode. In Timer Mode, the input clock for a timer is derived from the system clock, divided by a programmable prescaler, while Counter Mode allows a timer to be clocked in reference to external events.
Pulse width or duty cycle measurement is supported in Gated Timer Mode, where the operation of a timer is controlled by the 'gate' level on an external input pin. For these purposes, each timer has one associated port pin (TxIN) which serves as gate or clock input. The maximum resolution of the timers in module GPT1 is 4 system clock cycles.

The count direction (up/down) for each timer is programmable by software or may additionally be altered dynamically by an external signal on a port pin (TxEUD) to facilitate e.g. position tracking.

In Incremental Interface Mode the GPT1 timers (T2, T3, T4) can be directly connected to the incremental position sensor signals A and B via their respective inputs TxIN and TxEUD. Direction and count signals are internally derived from these two input signals, so the contents of the respective timer Tx corresponds to the sensor position. The third position sensor signal TOP0 can be connected to an interrupt input.

Timer T3 has an output toggle latch (T3OTL) which changes its state on each timer overflow/underflow. The state of this latch may be output on pin T3OUT e.g. for time out monitoring of external hardware components. It may also be used internally to clock timers T2 and T4 for measuring long time periods with high resolution.

In addition to their basic operating modes, timers T2 and T4 may be configured as reload or capture registers for timer T3. When used as capture or reload registers, timers T2 and T4 are stopped. The contents of timer T3 is captured into T2 or T4 in response to a signal at their associated input pins (TxIN). Timer T3 is reloaded with the contents of T2 or T4 triggered either by an external signal or by a selectable state transition of its toggle latch T3OTL. When both T2 and T4 are configured to alternately reload T3 on opposite state transitions of T3OTL with the low and high times of a PWM signal, this signal can be constantly generated without software intervention.

count direction (up/down) for each timer is programmable by software or may additionally be altered dynamically by an external signal on a port pin (TxEUD). Concatenation of the timers is supported via the output toggle latch (T6OTL) of timer T6, which changes its state on each timer overflow/underflow.

The state of this latch may be used to clock timer T5, and/or it may be output on pin T6OUT. The overflows/underflows of timer T6 can additionally be used to clock the CAPCOM1/2 timers, and to cause a reload from the CAPREL register.

The CAPREL register may capture the contents of timer T5 based on an external signal transition on the corresponding port pin (CAPIN), and timer T5 may optionally be cleared after the capture procedure. This allows the XC164S to measure absolute time differences or to perform pulse multiplication without software overhead.

The capture trigger (timer T5 to CAPREL) may also be generated upon transitions of GPT1 timer T3's inputs T3IN and/or T3EUD. This is especially advantageous when T3 operates in Incremental Interface Mode.

The RTC module can be used for different purposes:

- System clock to determine the current time and date, optionally during idle mode, sleep mode, and power down mode.
- Cyclic time based interrupt, to provide a system time tick independent of CPU frequency and other resources, e.g. to wake up regularly from idle mode.
- 48-bit timer for long term measurements (maximum timespan is >> 100 years).
- Alarm interrupt for wake-up on a defined time.

3.12 High Speed Synchronous Serial Channels (SSC0/SSC1)

The High Speed Synchronous Serial Channels SSC0/SSC1 support full-duplex and half-duplex synchronous communication. It may be configured so it interfaces with serially linked peripheral components, full SPI functionality is supported.

A dedicated baud rate generator allows to set up all standard baud rates without oscillator tuning. For transmission, reception and error handling three separate interrupt vectors are provided.

The SSC transmits or receives characters of 2 … 16 bits length synchronously to a shift clock which can be generated by the SSC (master mode) or by an external master (slave mode). The SSC can start shifting with the LSB or with the MSB and allows the selection of shifting and latching clock edges as well as the clock polarity.

A number of optional hardware error detection capabilities has been included to increase the reliability of data transfers. Transmit error and receive error supervise the correct handling of the data buffer. Phase error and baudrate error detect incorrect serial data.

Summary of Features

- Master or Slave mode operation
- Full-duplex or Half-duplex transfers
- Baudrate generation from 20 Mbit/s to 305.18 bit/s (@ 40 MHz)
- Flexible data format
  - Programmable number of data bits: 2 to 16 bits
  - Programmable shift direction: LSB-first or MSB-first
  - Programmable clock polarity: idle low or idle high
  - Programmable clock/data phase: data shift with leading or trailing clock edge
- Loop back option available for testing purposes
- Interrupt generation on transmitter buffer empty condition, receive buffer full condition, error condition (receive, phase, baudrate, transmit error)
- Three pin interface with flexible SSC pin configuration

3.17 Instruction Set Summary

Table 8 lists the instructions of the XC164S in a condensed way.
The various addressing modes that can be used with a specific instruction, the operation of the instructions, parameters for conditional execution of instructions, and the opcodes for each instruction can be found in the **"Instruction Set Manual"**.

This document also provides a detailed description of each instruction.

Table 8 Instruction Set Summary

Mnemonic	Description	Bytes
ADD(B)	Add word (byte) operands	2 / 4
ADDC(B)	Add word (byte) operands with Carry	2 / 4
SUB(B)	Subtract word (byte) operands	2 / 4
SUBC(B)	Subtract word (byte) operands with Carry	2 / 4
MUL(U)	(Un)Signed multiply direct GPR by direct GPR (16- × 16-bit)	2
DIV(U)	(Un)Signed divide register MDL by direct GPR (16-/16-bit)	2
DIVL(U)	(Un)Signed long divide reg. MD by direct GPR (32-/16-bit)	2
CPL(B)	Complement direct word (byte) GPR	2
NEG(B)	Negate direct word (byte) GPR	2
AND(B)	Bitwise AND, (word/byte operands)	2 / 4
OR(B)	Bitwise OR, (word/byte operands)	2 / 4
XOR(B)	Bitwise exclusive OR, (word/byte operands)	2 / 4
BCLR/BSET	Clear/Set direct bit	2
BMOV(N)	Move (negated) direct bit to direct bit	4
BAND/BOR/BXOR	AND/OR/XOR direct bit with direct bit	4
BCMP	Compare direct bit to direct bit	4
BFLDH/BFLDL	Bitwise modify masked high/low byte of bit-addressable direct word memory with immediate data	4
CMP(B)	Compare word (byte) operands	2 / 4
CMPD1/2	Compare word data to GPR and decrement GPR by 1/2	2 / 4
CMPI1/2	Compare word data to GPR and increment GPR by 1/2	2 / 4
PRIOR	Determine number of shift cycles to normalize direct word GPR and store result in direct word GPR	2
SHL/SHR	Shift left/right direct word GPR	2

Table 8 Instruction Set Summary (cont'd)

Mnemonic	Description	Bytes
NOP	Null operation	2
CoMUL/CoMAC	Multiply (and accumulate)	4
CoADD/CoSUB	Add/Subtract	4
Co(A)SHR	(Arithmetic) Shift right	4
CoSHL	Shift left	4
CoLOAD/STORE	Load accumulator/Store MAC register	4
CoCMP	Compare	4
CoMAX/MIN	Maximum/Minimum	4
CoABS/CoRND	Absolute value/Round accumulator	4
CoMOV	Data move	4
CoNEG/NOP	Negate accumulator/Null operation	4

5) Overload conditions occur if the standard operating conditions are exceeded, i.e. the voltage on any pin exceeds the specified range: $V_{OV} > V_{DDP} + 0.5$ V ($I_{OV} > 0$) or $V_{OV} < V_{SS} - 0.5$ V ($I_{OV} < 0$). The absolute sum of input overload currents on all pins may not exceed **50 mA**. The supply voltages must remain within the specified limits.
Proper operation is not guaranteed if overload conditions occur on functional pins such as XTAL1, $\overline{\text{RD}}$, $\overline{\text{WR}}$, etc.

6) Not subject to production test - verified by design/characterization.

7) An overload current (I_{OV}) through a pin injects a certain error current (I_{INJ}) into the adjacent pins. This error current adds to the respective pin's leakage current (I_{OZ}). The amount of error current depends on the overload current and is defined by the overload coupling factor K_{OV}. The polarity of the injected error current is inverse compared to the polarity of the overload current that produces it.
The total current through a pin is $|I_{TOT}| = |I_{OZ}| + (|I_{OV}| \times K_{OV})$. The additional error current may distort the input voltage on analog inputs.

8) The timing is valid for pin drivers operating in default current mode (selected after reset). Reducing the output current may lead to increased delays or reduced driving capability (C_L).

Parameter Interpretation

The parameters listed in the following partly represent the characteristics of the XC164S and partly its demands on the system. To aid in interpreting the parameters right, when evaluating them for a design, they are marked in column "Symbol":

CC (**C**ontroller **C**haracteristics):
The logic of the XC164S will provide signals with the respective characteristics.

SR (**S**ystem **R**equirement):
The external system must provide signals with the respective characteristics to the XC164S.

4.3 Analog/Digital Converter Parameters

Table 14 A/D Converter Characteristics (Operating Conditions apply)

Parameter	Symbol		Limit Values		Unit	Test Condition
			Min.	Max.		
Analog reference supply	V_{AREF}	SR	4.5	V_{DDP} + 0.1	V	1)
Analog reference ground	V_{AGND}	SR	V_{SS} - 0.1	V_{SS} + 0.1	V	–
Analog input voltage range	V_{AIN}	SR	V_{AGND}	V_{AREF}	V	2)
Basic clock frequency	f_{BC}		0.5	20	MHz	3)
Conversion time for 10-bit result[4]	t_{C10P}	CC	$52 \times t_{BC} + t_S + 6 \times t_{SYS}$		–	Post-calibr. on
	t_{C10}	CC	$40 \times t_{BC} + t_S + 6 \times t_{SYS}$		–	Post-calibr. off
Conversion time for 8-bit result[4]	t_{C8P}	CC	$44 \times t_{BC} + t_S + 6 \times t_{SYS}$		–	Post-calibr. on
	t_{C8}	CC	$32 \times t_{BC} + t_S + 6 \times t_{SYS}$		–	Post-calibr. off
Calibration time after reset	t_{CAL}	CC	484	11,696	t_{BC}	5)
Total unadjusted error	TUE	CC	–	±2	LSB	1)
Total capacitance of an analog input	C_{AINT}	CC	–	15	pF	6)
Switched capacitance of an analog input	C_{AINS}	CC	–	10	pF	6)
Resistance of the analog input path	R_{AIN}	CC	–	2	kΩ	6)
Total capacitance of the reference input	C_{AREFT}	CC	–	20	pF	6)
Switched capacitance of the reference input	C_{AREFS}	CC	–	15	pF	6)
Resistance of the reference input path	R_{AREF}	CC	–	1	kΩ	6)

1) TUE is tested at $V_{AREF} = V_{DDP} + 0.1$ V, $V_{AGND} = 0$ V. It is verified by design for all other voltages within the defined voltage range.
If the analog reference supply voltage drops below 4.5 V (i.e. $V_{AREF} \geq 4.0$ V) or exceeds the power supply voltage by up to 0.2 V (i.e. $V_{AREF} = V_{DDP} + 0.2$ V) the maximum TUE is increased to ±3 LSB. This range is not subject to production test.
The specified TUE is guaranteed only, if the absolute sum of input overload currents on Port 5 pins (see I_{OV} specification) does not exceed 10 mA, and if V_{AREF} and V_{AGND} remain stable during the respective period of time. During the reset calibration sequence the maximum TUE may be ±4 LSB.

2) V_{AIN} may exceed V_{AGND} or V_{AREF} up to the absolute maximum ratings. However, the conversion result in these cases will be $X000_H$ or $X3FF_H$, respectively.

3) The limit values for f_{BC} must not be exceeded when selecting the peripheral frequency and the ADCTC setting.
4) This parameter includes the sample time t_S, the time for determining the digital result and the time to load the result register with the conversion result ($t_{SYS} = 1/f_{SYS}$).
Values for the basic clock t_{BC} depend on programming and can be taken from **Table 15**.
When the post-calibration is switched off, the conversion time is reduced by $12 \times t_{BC}$.
5) The actual duration of the reset calibration depends on the noise on the reference signal. Conversions executed during the reset calibration increase the calibration time. The TUE for those conversions may be increased.
6) Not subject to production test - verified by design/characterization.
The given parameter values cover the complete operating range. Under relaxed operating conditions (temperature, supply voltage) reduced values can be used for calculations. At room temperature and nominal supply voltage the following typical values can be used:
$C_{AINTtyp}$ = 12 pF, $C_{AINStyp}$ = 7 pF, R_{AINtyp} = 1.5 kΩ, $C_{AREFTtyp}$ = 15 pF, $C_{AREFStyp}$ = 13 pF, $R_{AREFtyp}$ = 0.7 kΩ.

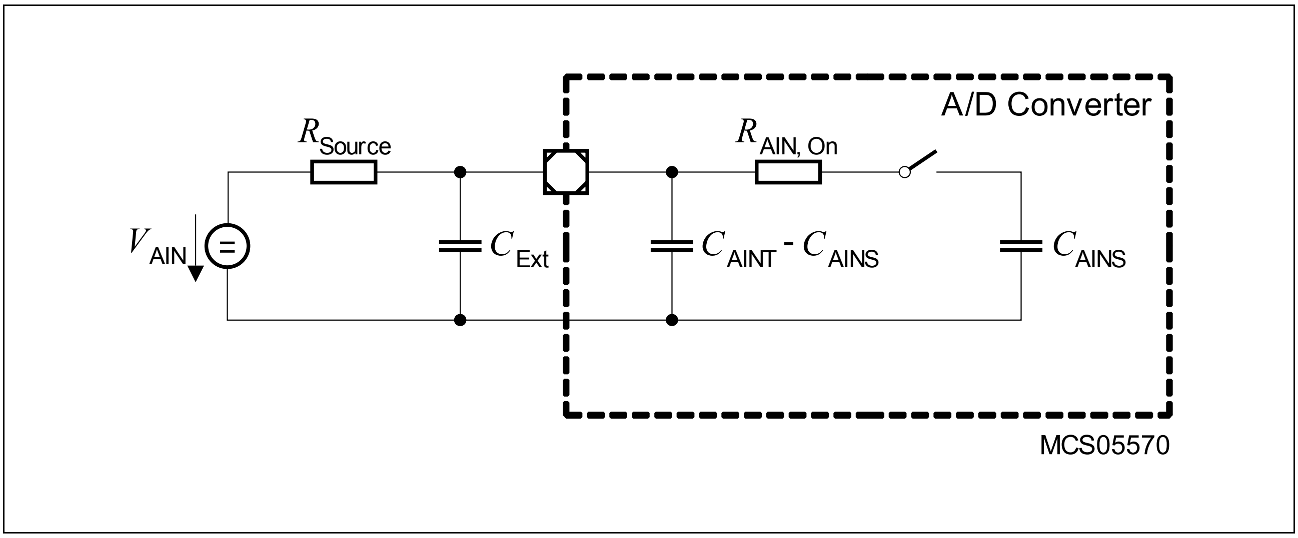

Figure 13 Equivalent Circuitry for Analog Inputs

4.4.3 External Clock Drive XTAL1

Table 19 External Clock Drive Characteristics (Operating Conditions apply)

Parameter	Symbol		Limit Values		Unit
			Min.	Max.	
Oscillator period	t_{OSC}	SR	25	250[1]	ns
High time[2]	t_1	SR	6	–	ns
Low time[2]	t_2	SR	6	–	ns
Rise time[2]	t_3	SR	–	8	ns
Fall time[2]	t_4	SR	–	8	ns

1) The maximum limit is only relevant for PLL operation to ensure the minimum input frequency for the PLL.

2) The clock input signal must reach the defined levels V_{ILC} and V_{IHC}.

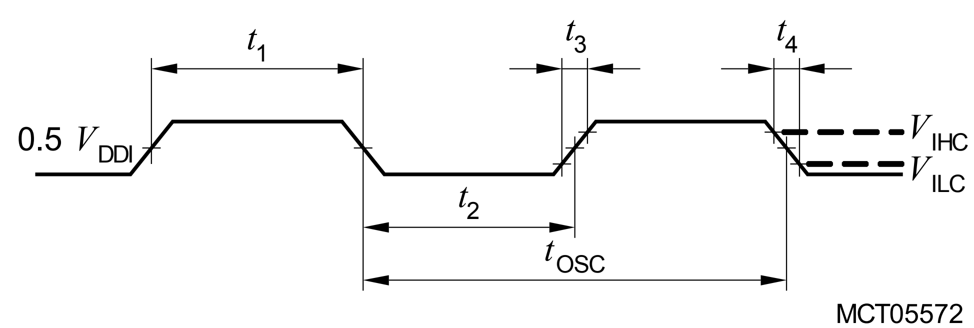

Figure 16 External Clock Drive XTAL1

Note: If the on-chip oscillator is used together with a crystal or a ceramic resonator, the oscillator frequency is limited to a range of 4 MHz to 16 MHz.
It is strongly recommended to measure the oscillation allowance (negative resistance) in the final target system (layout) to determine the optimum parameters for the oscillator operation. Please refer to the limits specified by the crystal supplier.
When driven by an external clock signal it will accept the specified frequency range. Operation at lower input frequencies is possible but is verified by design only (not subject to production test).

4.4.5 External Bus Timing

Table 20 CLKOUT Reference Signal

Parameter	Symbol		Limit Values		Unit
			Min.	Max.	
CLKOUT cycle time	tc_5	CC	40/30/25[1]		ns
CLKOUT high time	tc_6	CC	8	–	ns
CLKOUT low time	tc_7	CC	6	–	ns
CLKOUT rise time	tc_8	CC	–	4	ns
CLKOUT fall time	tc_9	CC	–	4	ns

1) The CLKOUT cycle time is influenced by the PLL jitter (given values apply to f_{CPU} = 25/33/40 MHz). For longer periods the relative deviation decreases (see PLL deviation formula).

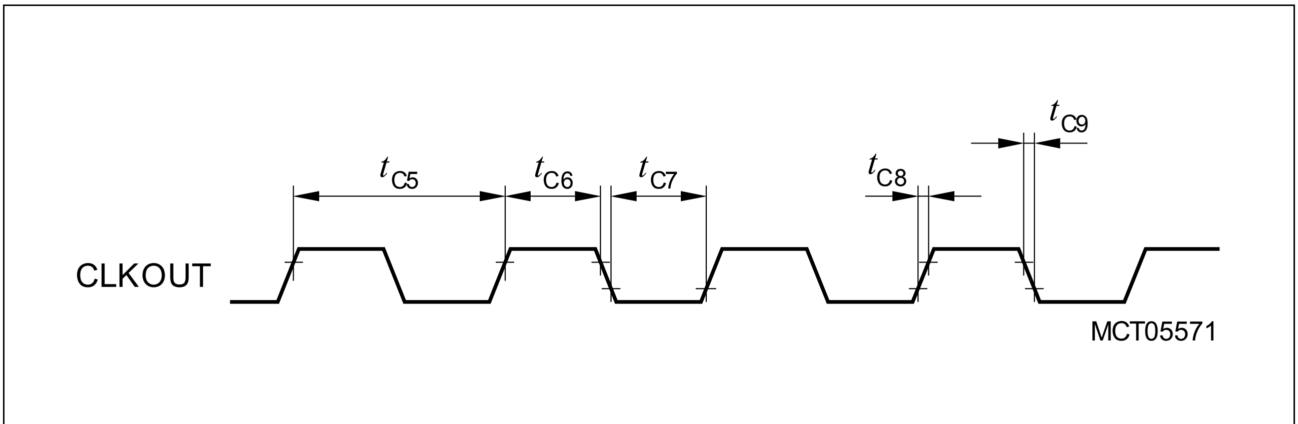

Figure 19 CLKOUT Signal Timing

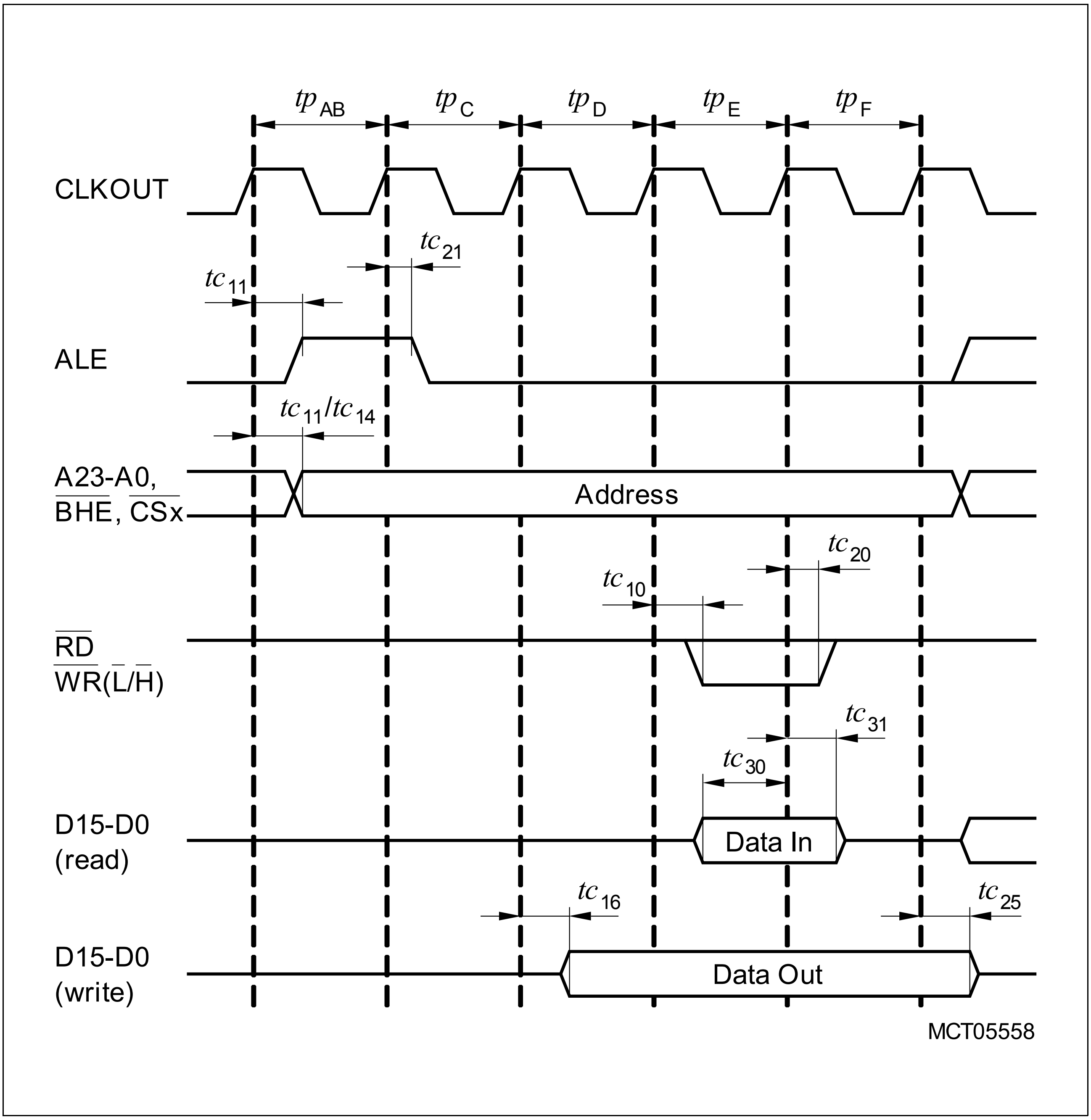

Figure 21 Demultiplexed Bus Cycle